

Marking of Hazardous Substances according to SJ/T 11364-2014 (“China-ROHS”) for Industrial PCs



有毒有害物质或元素名称及含量标识

Component Name 面板式PC 及其配件	“EFUP” 环保使用期限	Lead (Pb) 铅	Mercury (Hg) 汞	Cadmium (Cd) 镉	Hexavalent Chromium (Cr(VI)) 六价铬	Poly-brominated Biphenyls (PBB) 多溴联苯	Poly-brominated Diphenyl Ethers (PBDE) 多溴二苯醚
Mechanical assembly (plastic parts) 塑料部件		○	○	○	○	○	○
Mechanical assembly (metal parts) 金属部件		○	○	○	○	○	○
Assembled printed circuit boards (APCB) 电路板	50	×	○	○	○	○	○
Connectors 接头	50	×	○	○	○	○	○
Cables without connector 无接头电缆		○	○	○	○	○	○
TFT displays 液晶显示器		○	○	○	○	○	○
Recommended preventative exchange of IPC components							
Cooling fans 风扇	7	×	○	○	○	○	○
HDDs 系统	5	×	○	○	○	○	○
Batteries (Li metal cell) 电池		○	○	○	○	○	○

These tables are prepared in accordance with the provisions of SJ/T 11364.

以上表格依据SJ/T 11364 的规定编制

○: The content of such hazardous substance in all homogeneous materials of such component is below the limit required by GB/T 26572.

○: 表示该有害物质在该部件所有均质材料中的含量均在GB/T26572规定的限量要求以下。

×: The content of such hazardous substance in a certain homogeneous material of such component is beyond the limit required by GB/T 26572.

×: 表示该有害物质至少在该部件的某一均质材料中的含量超出 GB/T26572 规定的限量要求

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In case of:							
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SSD, CF card, CFast, M.2, Micro SD, plug-in cards, motherboard, RAM memory		×	○	○	○	○	○
CD/DVD drive, power supply unit C9900-Dxxx, C9900-Pxxx		×	○	○	○	○	○
Mechanical assembly C9900-Fxxx, C9900-Mxxx, C9900-Txxx		×	○	○	○	○	○
Battery pack with UPS C9900-Uxxx 不间断电源		×	○	○	○	○	○
Cable with connector C9900-Kxxx 有接头电缆		×	○	○	○	○	○
Push button extension C99xx-Exxx 按钮		×	○	○	○	○	○
Accessories for DIN rail mounting DIN 导轨安排部件		×	○	○	○	○	○

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		The Environmentally Friendly Use Period (EFUP) for all enclosed products and their parts are per the symbol shown here, unless otherwise marked				
 Component Name 部件名称 嵌入式PC及其配件	Lead (Pb) 铅	Mercury (Hg) 汞	Cadmium (Cd) 镉	Hexavalent Chromium (Cr(VI)) 六价铬	Poly-brominated Biphenyls (PBB) 多溴联苯	Poly-brominated Diphenyl Ethers (PBDE) 多溴二苯醚
Mechanical assembly (plastic parts) 塑料部件	○	○	○	○	○	○
Mechanical assembly (metal parts) 金属部件	○	○	○	○	○	○
Assembled printed circuit board (APCB) 电路板	×	○	○	○	○	○
Mechanical assembly (connector) 接头	×	○	○	○	○	○
Cables 电缆	○	○	○	○	○	○
Battery (Li metal cell) 电源	○	○	○	○	○	○
SSD, CF card, CFast, M.2, Micro SD 内存卡	×	○	○	○	○	○
FSTN-Display 显示器	×	○	○	○	○	○

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○: 表示该有害物质在该部件所有均质材料中的含量均在GB/T26572规定的限量要求以下。

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Recommended preventative exchange of IPC components							
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Cooling fan 风扇		×	○	○	○	○	○
Power supply unit and I/O interfaces 电源		×	○	○	○	○	○
Fieldbus master		×	○	○	○	○	○
Fieldbus slave		×	○	○	○	○	○

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×: *The content of such hazardous substance in a certain homogeneous material of such component is beyond the limit required by GB/T 26572.*

×: 表示该有害物质至少在该部件的某一均质材料中的含量超出GB/T26572 规定的限量要求。